

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No.

Volker BECKER et al.

09/674,984

Filed

January 8, 2001

For

A DEVICE AND METHOD FOR DETERMINING THE LATERAL UNDERCUT OF A STRUCTURED SURFACE

LAYER

Examiner

William D. Coleman

Group Art Unit

2823

Commissioner for Patents Washington, D.C. 20231

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AMENDMENT AFTER FINAL OFFICE ACTION UNDER § 1.116

SIR:

In response to the final Office Action mailed October 21, 2002, please amend the aboveidentified application as set forth below. Entry of the amendment is respectfully requested since the amendment raises no new issues and puts the rejected claims in condition for allowance and/or in better form for appeal.

IN THE CLAIMS:

Please amend claims 23 as follows:

23. (Twice Amended) A device for determining an extent of an at least locally etched lateral undercut of a structured surface layer on a sacrificial layer, comprising:

at least one passive electronic component arranged on the structured surface layer and in the shape of a coil for determining a physical measured quantity that is proportional to the extent of the etched lateral undercut.